ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES®	burn, Illinois. A	ll rights reserved un tions.	nder both le	This docume evel parts, t	ent is a declarati he declaration e	on of the subs	stances wi all lower le	ithin the manufacture evel materials for wh	er listed it nich the m	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information or http://www.ipc.org/IPC-175x	.1 IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribu			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				als and Mfg Information					
Supplier Information													
Company name* Company unique ID				Unique ID Authority					Response Date*				
onsemi	asemi								2025-06-06				
Contact Name	Title - Contact				Phone - Contact*				Email - Contact*				
roduct-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance			NA			Р			Product	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	n Number	Mfr Item Name			Effective Date	Version	Ma	Manufacturing Site		Veight*	UOM	Unit Type	
NSBC	C123JF3T5G SOT-1123 NBRT T		TRANSISTOR		2025-06-06		CN1		0	.45	mg	Each	
Manufacturing Proccess Information		•							<u>}</u>		·	·	
Terminal Plating / Grid Array Material	al Terminal Base Alloy J-		-STD-020 MSL I	Rating	Peak Process Body Temperat		nperature	ure Max Time at Peak Tempera		ire Numb	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy 1					260	0	2	30	second	ls 3			
Comments													
level 1 - maximum time at peak temperature during s	oldering is 10-3	0 seconds											
For more information regarding material compositio	n please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted	
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg	
Lead Frame	0.2	mg	Supplier	Silver (Ag)	7440-22-4		0.0356	mg	
			В	Nickel (Ni)	7440-02-0		0.0618	mg	
			Supplier	Iron (Fe)	7439-89-6		0.0854	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0172	mg	
Mold Compound-Black	0.19	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.019	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0009	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0275	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.1235	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.019	mg	
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg	
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg	